## QOCVO

### **SiC JFET Division**

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#### Silicon Carbide (SiC) Diode - EliteSiC, TO-247-2L, 20 A, 1200 V SiC Merged PiN-Schottky (MPS) Diode

Rev. C, Jan 2025

#### Description

UnitedSiC offers the 3<sup>rd</sup> generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175°C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.

#### Features

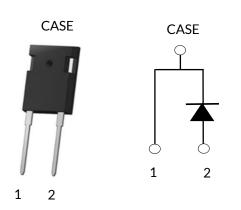
- Maximum operating temperature of 175°C
- Easy paralleling
- Extremely fast switching not dependent on temperature
- No reverse or forward recovery
- Enhanced surge current capability, MPS structure
- 100% UIS tested
- AEC-Q101 qualified

#### Typical applications

- Power converters
- Industrial motor drives
- Switch mode power supplies
- Power factor correction modules

# J3D1220K2

DATASHEET



Part Number	Package	Marking
UJ3D1220K2	TO-247-2L	UJ3D1220K2







#### Maximum Ratings

Parameter	Symbol	<b>Test Conditions</b>	Value	Units	
DC blocking voltage	V <sub>R</sub>		1200	V	
Repetitive peak reverse voltage, T <sub>J</sub> =25°C	V <sub>RRM</sub>		1200	V	
Surge peak reverse voltage	V <sub>RSM</sub>		1200	V	
Maximum DC forward current	I <sub>F</sub>	T <sub>C</sub> = 135°C	20	А	
Non-repetitive forward surge current	1	$T_{C} = 25^{\circ}C, t_{p} = 10ms$	190	А	
sine halfwave	I <sub>FSM</sub>	T <sub>C</sub> = 110°C, t <sub>p</sub> = 10ms	180		
Repetitive forward surge current		T <sub>C</sub> = 25°C, t <sub>p</sub> = 10ms	71.9	А	
sine halfwave, D=0.1	I <sub>FRM</sub>	T <sub>C</sub> = 110°C, t <sub>p</sub> = 10ms	40.9		
	I <sub>F,max</sub>	T <sub>C</sub> = 25°C, t <sub>p</sub> = 10μs	1300		
Non-repetitive peak forward current		T <sub>C</sub> = 110°C, t <sub>p</sub> = 10μs	1300	A	
-2	(·2 ·	$T_{c} = 25^{\circ}C, t_{p} = 10ms$	181	A <sup>2</sup> s	
i <sup>2</sup> t value	∫i <sup>2</sup> dt –	$T_{\rm C}$ = 110°C, $t_{\rm p}$ = 10ms	162		
Power dissipation	D	T <sub>C</sub> = 25°C	205	W	
	P <sub>tot</sub> –	T <sub>C</sub> = 135°C	55		
Maximum junction temperature	T <sub>J,max</sub>		175	°C	
Operating and storage temperature	T <sub>J</sub> , T <sub>STG</sub>		-55 to 175	°C	
Soldering temperatures, wavesoldering only allowed at leads	T <sub>sold</sub>	1.6mm from case for 10s	260	°C	

#### **Thermal Characteristics**

Darameter	Symbol	Test Conditions	Value			Units
Parameter			Min	Тур	Max	Units
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.56	0.73	°C/W



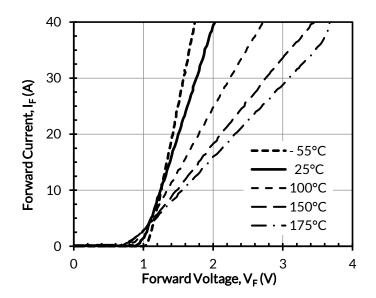
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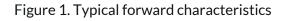
#### Electrical Characteristics (T<sub>J</sub> = +25°C unless otherwise specified)

Parameter	Symbol	Test Conditions	Value			Linite
			Min	Тур	Max	Units
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 20A, T <sub>J</sub> =25°C	-	1.52	1.7	V
		I <sub>F</sub> = 20A, T <sub>J</sub> =150°C	-	2.15		
		I <sub>F</sub> = 20A, T <sub>J</sub> =175°C	-	2.25		
Reverse current	I <sub>R</sub>	V <sub>R</sub> =1200V, T <sub>J</sub> =25°C	-	18	190	μΑ
		V <sub>R</sub> =1200V, T <sub>J</sub> =175°C	-	500		
Total capacitive charge <sup>(1)</sup>	Q <sub>C</sub>	V <sub>R</sub> =800V		83		nC
Total capacitance	С	$V_R$ =1V, f = 1MHz		810		pF
		V <sub>R</sub> =400V, f = 1MHz		75		
		V <sub>R</sub> =800V, f = 1MHz		69		
Capacitance stored energy	E <sub>C</sub>	V <sub>R</sub> =800V		24.5		μJ

(1)  $Q_c$  is independent on  $T_J$ ,  $di_F/dt$ , and  $I_F$  as shown in the application note USCi\_AN0011.

#### **Typical Performance Diagrams**





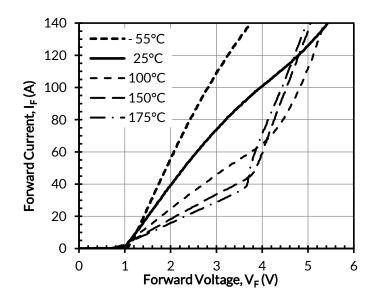
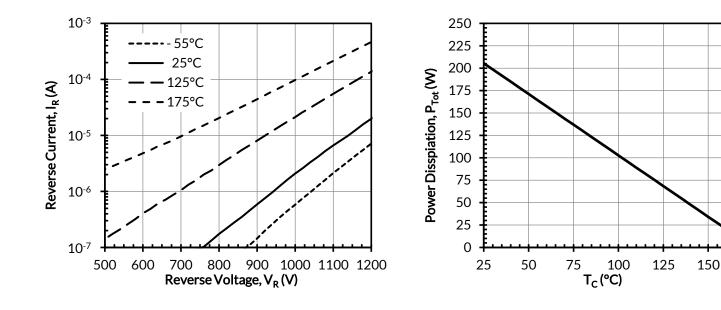


Figure 2. Typical forward characteristics in surge current





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Figure 3. Typical reverse characteristics

Figure 4. Power dissipation

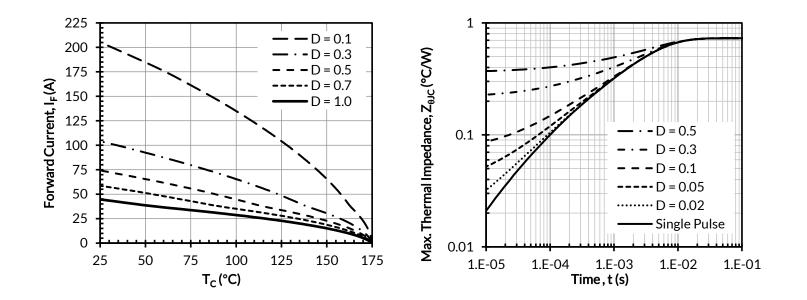


Figure 5. Diode forward current

Figure 6. Maximum transient thermal impedance





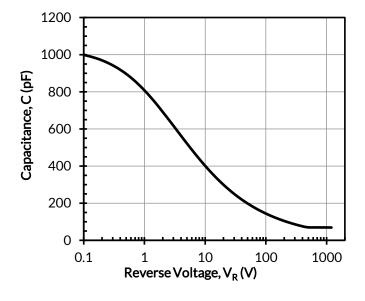


Figure 7. Capacitance vs. reverse voltage at 1MHz

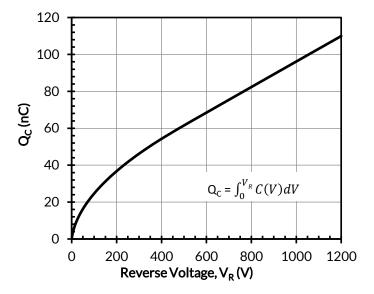


Figure 8. Typical capacitive charge vs. reverse voltage

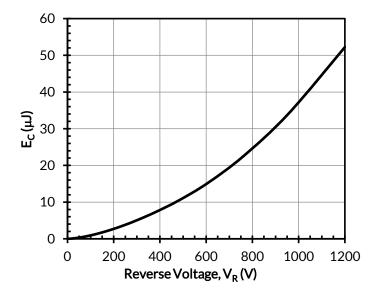


Figure 9. Typical capacitance stored energy vs. reverse voltage









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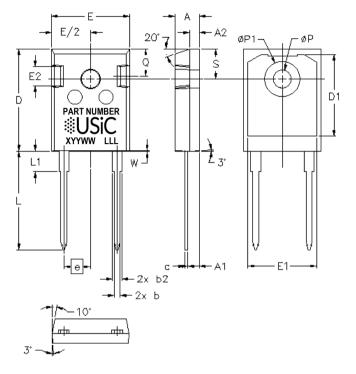
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### TO-247-2L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

#### **PACKAGE OUTLINE**



SYM	INCHES		MILLIN	<b>IETERS</b>
	MIN	MAX	MIN	MAX
A	0.185	0.209	4.70	5.31
A1	0.087	0.102	2.21	2.61
A2	0.059	0.098	1.50	2.49
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
С	0.015	0.035	0.38	0.89
D	0.819	0.845	20.80	21.46
D1	0.515	-	13.08	-
D2	0.02	0.053	0.51	1.35
E	0.610	0.640	15.49	16.26
е	0.214 BSC		5.44 BSC	
E1	0.530	-	13.46	-
E2	0.135	0.157	3.43	3.99
L	0.780	0.800	19.81	20.32
L1	-	0.177	-	4.50
ØР	0.140	0.144	3.56	3.66
ØP1	0.278	0.291	7.06	7.39
Q	0.212	0.244	5.39	6.20
S	0.243	3 BSC	6.17	BSC
W	-	0.006	-	0.15



#### PART MARKING

# PART NUMBER Silver Silv

PART NUMBER = REFER TO DS\_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

#### PACKING TYPE

ANTI-STATIC TUBE

**QUANTITY / TUBE : 30 UNITS** 

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